



**ELECTROSTATIC SENSITIVE DEVICE**  
OBSERVE HANDLING PRECAUTIONS

**MITSUBISHI RF POWER MOS FET**

# RD60HUF1

**RoHS Compliance, Silicon MOSFET Power Transistor 520MHz,60W**

## DESCRIPTION

RD60HUF1 is a MOS FET type transistor specifically designed for UHF High power amplifiers applications.

## FEATURES

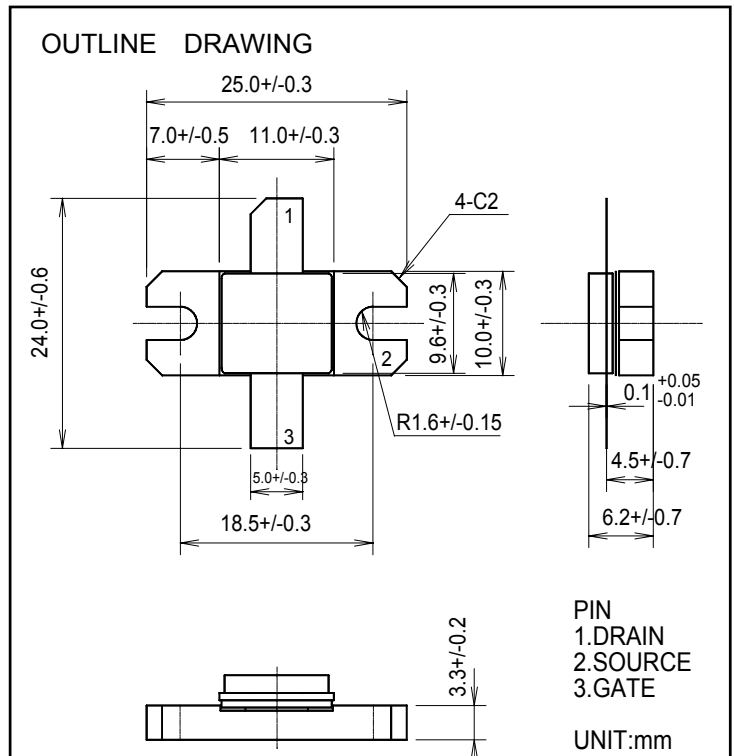
High power and High Gain:  
Pout>60W, Gp>7.7dB @Vdd=12.5V,f=520MHz  
High Efficiency: 55%typ.on UHF Band

## APPLICATION

For output stage of high power amplifiers in UHF Band mobile radio sets.

## RoHS COMPLIANT

RD60HUF1-101 is a RoHS compliant products.  
RoHS compliance is indicate by the letter "G" after the Lot Marking.



## ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

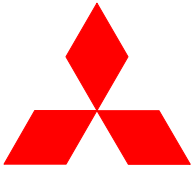
SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
Vdss	Drain to source voltage	Vgs=0V	30	V
Vgss	Gate to source voltage	Vds=0V	+/-20	V
Pch	Channel dissipation	Tc=25°C	150	W
Pin	Input power	Zg=Zl=50Ω	20	W
ID	Drain current	-	20	A
Tch	Channel temperature	-	175	°C
Tstg	Storage temperature	-	-40 to +175	°C
Rth j-c	Thermal resistance	junction to case	1.0	°C/W

Note 1: Above parameters are guaranteed independently.

## ELECTRICAL CHARACTERISTICS (Tc=25°C, UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX.	
Idss	Zerogate voltage drain current	VDS=17V, VGS=0V	-	-	400	uA
Igss	Gate to source leak current	VGS=10V, VDS=0V	-	-	1	uA
VTH	Gate threshold voltage	VDS=12V, Ids=1mA	1.1	1.45	1.8	V
Pout	Output power	f=520MHz, VDD=12.5V	60	65	-	W
ηD	Drain efficiency	Pin=10W, Idq=2.5A	50	55	-	%
	Load VSWR tolerance	VDD=15.2V, Po=60W(PinControl) f=520MHz, Idq=2.5A, Zg=50Ω Load VSWR=20:1(All Phase)	No destroy			-

Note : Above parameters , ratings , limits and conditions are subject to change.



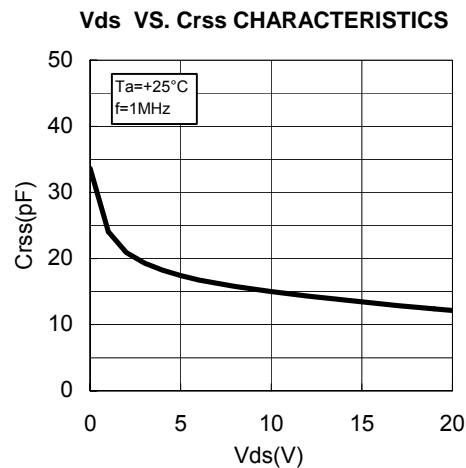
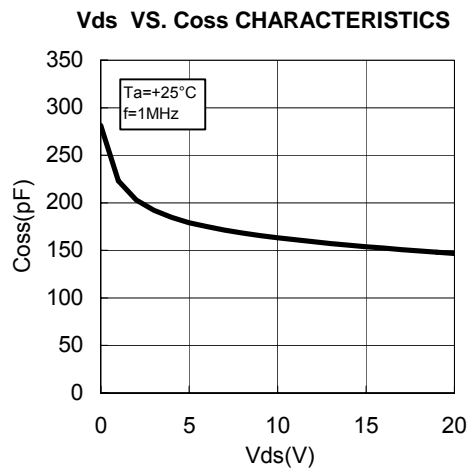
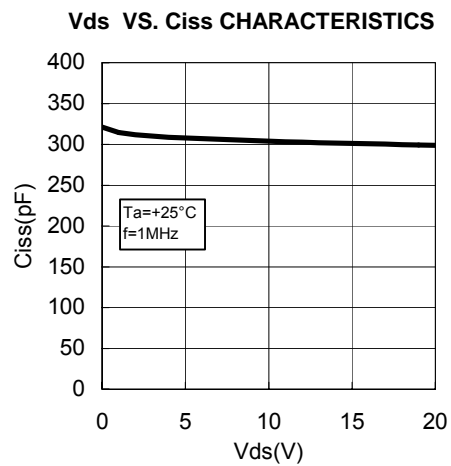
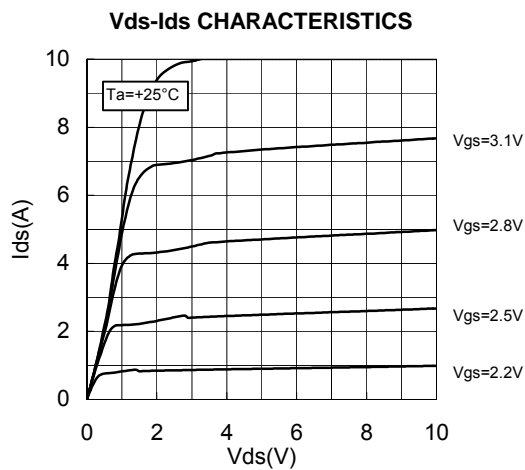
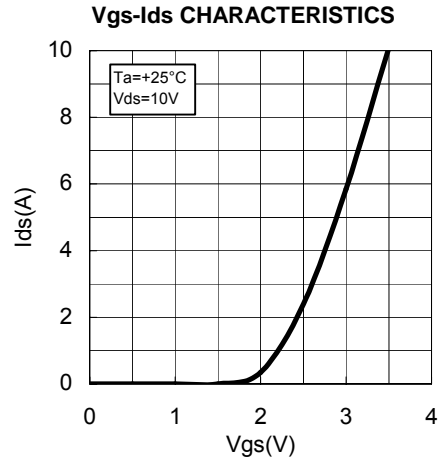
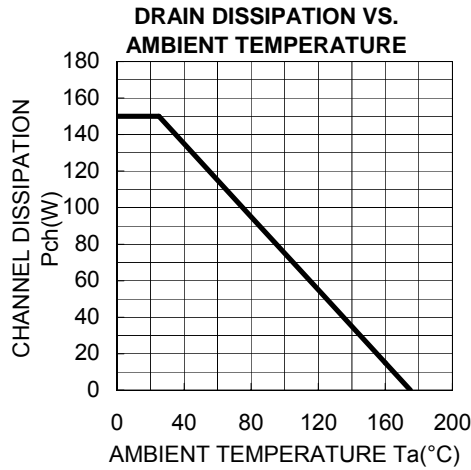
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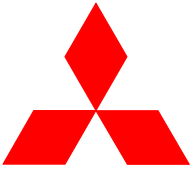
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## TYPICAL CHARACTERISTICS





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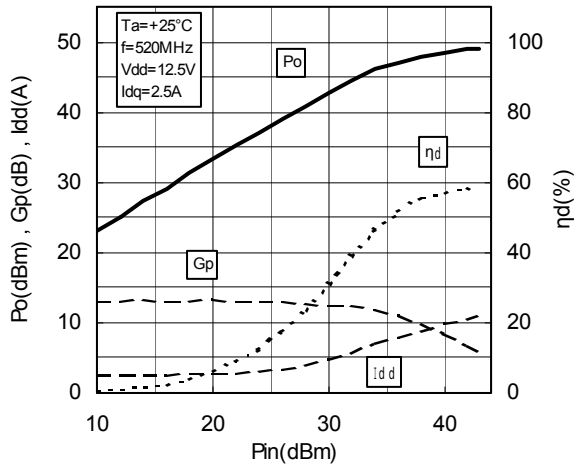
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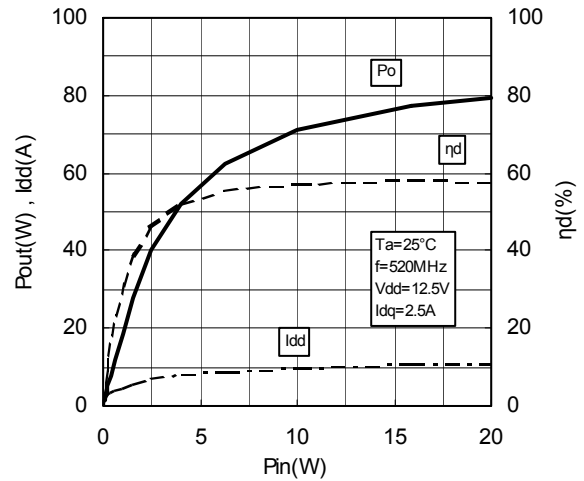
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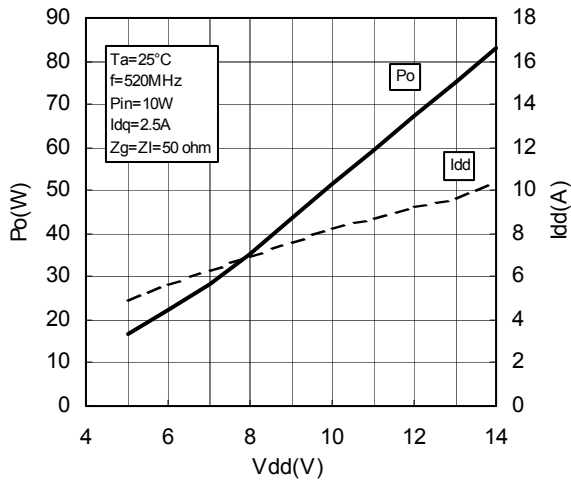
Pin-Po CHARACTERISTICS



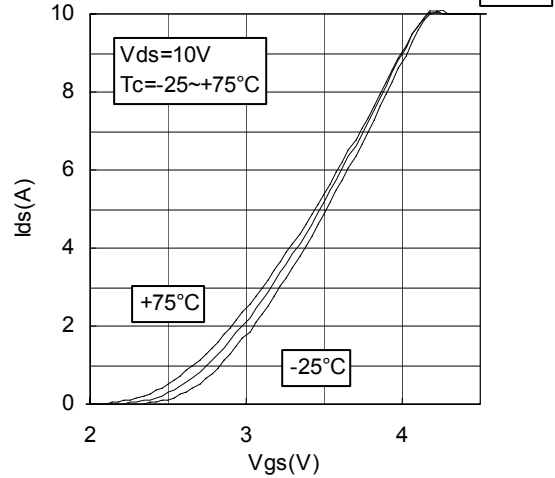
Pin-Po CHARACTERISTICS

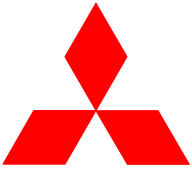


Vdd-Po CHARACTERISTICS



Vgs-Ids CHARACTERISTICS 2





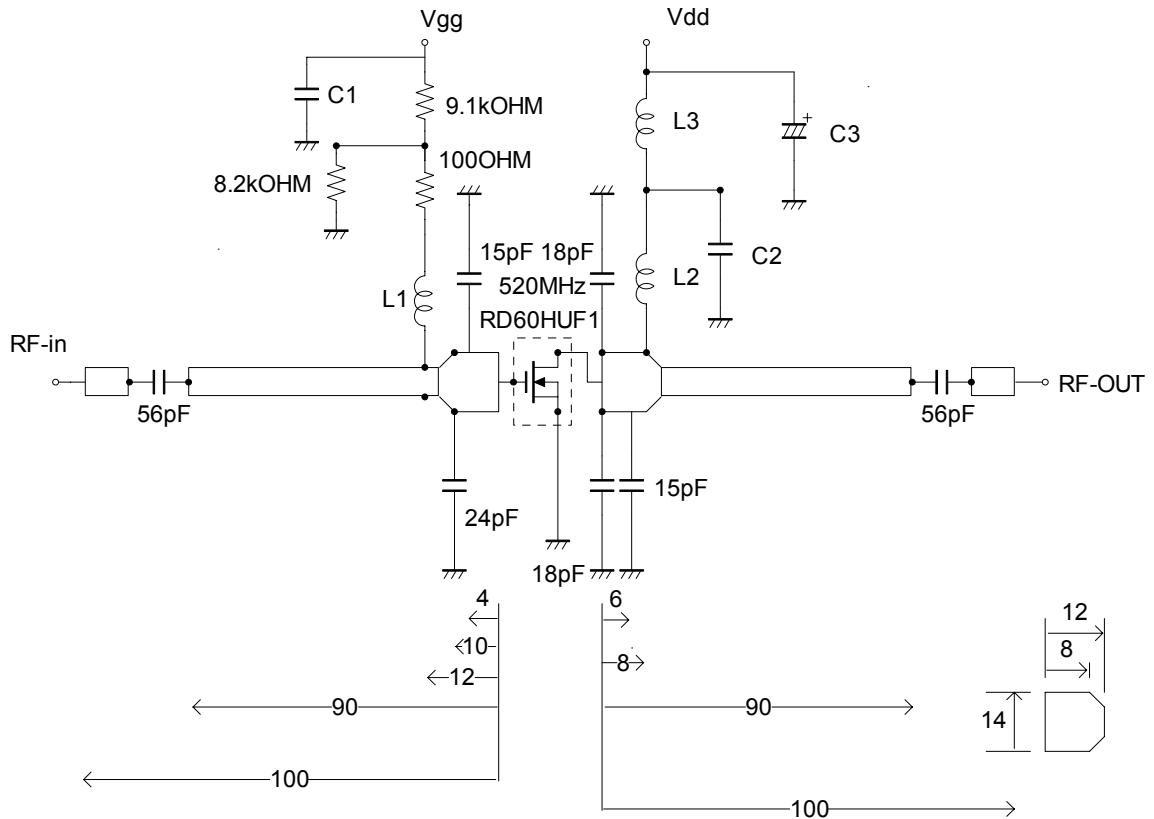
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**TEST CIRCUIT(f=520MHz)**

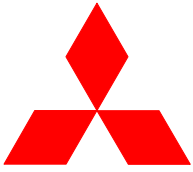


- C1:2200pF 10uf in parallel
- C2:2200pF\*2 in parallel
- C3:2200pF,330uF in parallel

- L1:4Turns,I,D6mm,D1.6mm P=1 silver plateted copper wire
- L2:2Turns,I,D6mm,D1.6mm P=1 silver plateted copper wire
- L3:4Turns,I,D6mm,D1.6mm P=1 silver plateted copper wire

Note:Board material-Teflon substrate  
micro strip line width=4.2mm/50OHM,er:2.7,t=1.6mm

Dimensions:mm



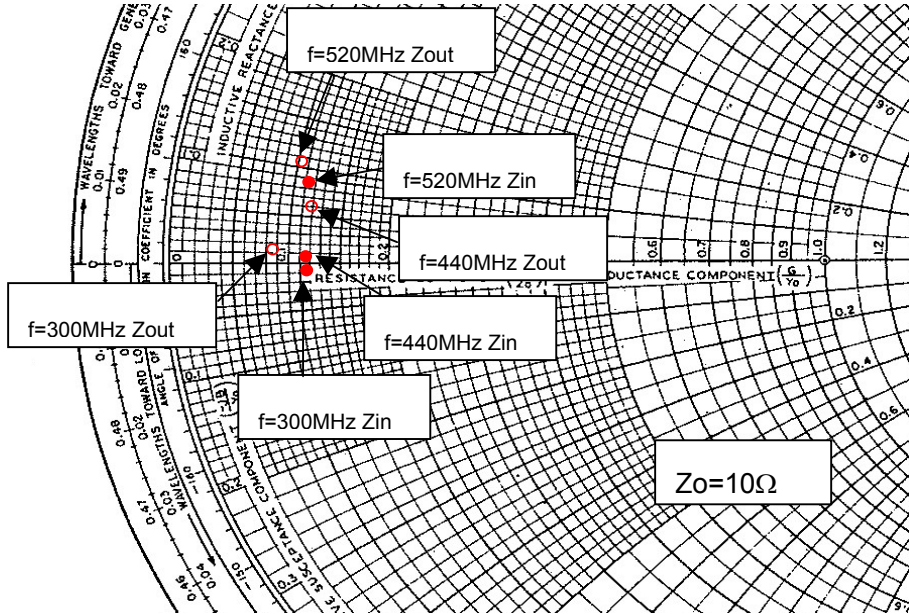
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## INPUT/OUTPUT IMPEDANCE VS.FREQUENCY CHARACTERISTICS



Z<sub>in</sub> , Z<sub>out</sub>

f (MHz)	Z <sub>in</sub> (ohm)	Z <sub>out</sub> (ohm)	Conditions
300	1.16-j0.06	0.83+j0.14	
440	1.18+j0.09	1.20+j0.58	P <sub>o</sub> =65W, V <sub>dd</sub> =12.5V, P <sub>in</sub> =10W
520	1.15+j0.86	1.05+j1.09	P <sub>o</sub> =60W, V <sub>dd</sub> =12.5V, P <sub>in</sub> =10W



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RD60HUF1 S-PARAMETER DATA (@V<sub>dd</sub>=12.5V, I<sub>d</sub>=500mA)

Freq. [MHz]	S11		S21		S12		S22	
	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
10	0.909	-156.8	30.933	98.0	0.012	8.6	0.788	-166.6
50	0.910	-177.1	6.014	75.6	0.011	-10.8	0.811	-177.2
100	0.923	178.6	2.796	60.1	0.010	-25.0	0.845	-178.5
150	0.935	175.5	1.678	46.1	0.008	-32.2	0.869	178.3
175	0.944	173.9	1.351	40.5	0.008	-39.0	0.877	177.0
200	0.949	172.5	1.109	36.2	0.007	-41.7	0.893	175.6
250	0.957	169.2	0.804	27.2	0.005	-42.3	0.930	172.3
300	0.961	166.2	0.583	18.3	0.004	-40.2	0.930	169.2
350	0.964	163.3	0.450	12.0	0.003	-21.8	0.945	166.0
400	0.969	159.8	0.368	6.8	0.002	-4.8	0.957	162.4
450	0.974	157.0	0.296	2.3	0.002	38.1	0.956	159.5
500	0.975	153.8	0.238	-3.0	0.003	38.4	0.962	156.5
550	0.977	151.0	0.209	-6.1	0.003	49.4	0.965	153.4
600	0.978	147.8	0.178	-14.1	0.005	53.8	0.963	150.1
650	0.982	145.1	0.155	-17.5	0.006	54.4	0.971	147.4
700	0.983	141.9	0.136	-19.6	0.006	50.3	0.973	144.5
750	0.979	139.5	0.113	-17.5	0.007	51.8	0.972	141.5
800	0.982	136.7	0.104	-20.2	0.009	56.2	0.980	138.4
850	0.985	133.7	0.103	-33.7	0.009	49.6	0.978	136.2
900	0.980	130.9	0.084	-27.4	0.010	46.5	0.975	133.1
950	0.981	128.0	0.083	-35.1	0.010	47.2	0.983	130.4
1000	0.981	124.9	0.071	-28.7	0.012	43.8	0.984	128.0



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Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.